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August 2015

FCPF650N80Z — N-Channel SuperFET[®] II MOSFET

FCPF650N80Z

N-Channel SuperFET[®] II MOSFET

800 V, 10 A, 650 m Ω

Features

- R_{DS(on)} = 530 mΩ (Typ.)
- Ultra Low Gate Charge (Typ. Q_g = 27 nC)
- Low E_{oss} (Typ. 2.8 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 124 pF)
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

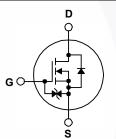
Applications

- AC DC Power Supply
- LED Lighting

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

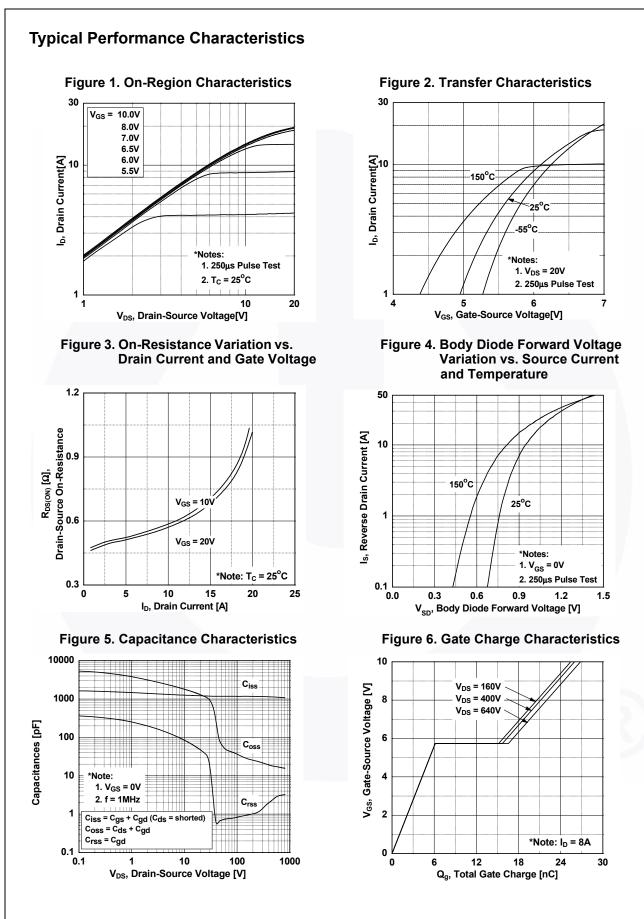
Symbol		FCPF650N80Z	Unit			
V _{DSS}	Drain to Source Voltage	800	V			
V _{GSS}		- DC	- DC			
	Gate to Source Voltage	- AC	- AC (f > 1 Hz)			
I _D	Drain Current	- Continuous (T _C = 25 ^o C)	10*	•		
	Drain Current	- Continuous (T _C = 100 ^o C)		6.3*	Α	
I _{DM}	Drain Current	- Pulsed	(Note 1)	24*	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			204	mJ	
I _{AR}	Avalanche Current (Note 1)			1.6	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)			0.305	mJ	
dv/dt	MOSFET dv/dt	100	V/ns			
	Peak Diode Recovery dv/dt	20				
P _D	Dower Dissinction	(T _C = 25°C)		30.5	W	
	Power Dissipation	- Derate Above 25°C	- Derate Above 25°C			
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

*Drain current limited by maximum junction temperature, with heatsink.

Thermal Characteristics

Symbol	Parameter	FCPF650N80Z	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	4.1	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	C/W	

Part Nur	Part Number Top Mark Pa		Packa	ckage Packing Method Reel Si		ize	Tape Widt	th Q	uantity		
FCPF650			TO-22	20F	Tube	N/A		N/A	5	50 units	
Electrica	l Char	acteristics T _C =2	5ºC unles	ss othe	erwise noted.						
Symbol		Parameter		Test Conditions			Min.	Тур.	Max.	Unit	
Off Charac	teristic	s									
BV _{DSS}		Source Breakdown Volt	age \	/	0 V, I _D = 1 mA, T _J =	25°C	800	_	-	V	
ΔBV_{DSS}	Breakdown Voltage Temperature		~								
$/\Delta T_{J}$	Coefficient			$I_D = 1 \text{ mA}$, Referenced to 25° C			-	0.8	-	V/ºC	
	7			V _{DS} = 800 V, V _{GS} = 0 V			-	-	25		
IDSS	Zero Ga	ate Voltage Drain Curren	τ	$V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$			-	-	250	μΑ	
I _{GSS}	Gate to	to Body Leakage Current		V _{GS} = ±20 V, V _{DS} = 0 V			-	-	±10	μA	
On Charac	teristic	s									
V _{GS(th)}	Gate TI	nreshold Voltage	N	/ _{GS} =	V _{DS} , I _D = 0.8 mA		2.5	-	4.5	V	
R _{DS(on)}		rain to Source On Resis		00	10 V, I _D = 4 A		-	530	650	mΩ	
9 _{FS}	Forwar	d Transconductance			20 V, I _D = 4 A		-	7.8	-	S	
Dynamic C	haracte	eristics						1			
C _{iss}		apacitance						1178	1565	pF	
C _{oss}	-	Capacitance		V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz		-	36	48	pF		
C _{rss}		e Transfer Capacitance	f				0.84	-	pF		
C _{oss}		Output Capacitance		V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz			-	18	-	pF	
C _{oss (eff.)}	Effective Output Capacitance			$V_{\rm DS} = 0.00 \text{v}, V_{\rm GS} = 0.0 \text{v}, 1 = 1.00 \text{v}$			-	124	_	pF	
Q _{g(tot)}		ate Charge at 10V					-	27	35	nC	
Q_{gs}		Source Gate Charge		V _{DS} = 640 V, I _D = 8 A, V _{GS} = 10 V		-	6	-	nC		
Q _{gd}		Drain "Miller" Charge		GS		(Note 4)	-	11	-	nC	
ESR		ent Series Resistance	f	= 1 M	IHz	. ,	-	1.9	_	Ω	
	- I							1.0			
Switching	-								1		
t _{d(on)}		n Delay Time			100.1/1 0.4		-	17	44	ns	
t _r		Rise Time		V_{DD} = 400 V, I _D = 8 A, V_{GS} = 10 V, R _g = 4.7 Ω (Note 4)		-	11	32	ns		
t _{d(off)}		f Delay Time	· · · · ·			-	40	90	ns		
t _f	Turn-Of	f Fall Time				(Note 4)	-	3.4	17	ns	
Drain-Sou	rce Dio	de Characteristics									
I _S	Maximu	m Continuous Drain to S	ource Dic	ode Fo	orward Current		-	-	10	Α	
I _{SM}	Maximu	m Pulsed Drain to Sourc	e Diode F	orwa	rd Current		-	-	24	Α	
V _{SD}	Drain to	Source Diode Forward	Voltage	V _{GS} =	0 V, I _{SD} = 8 A		-	-	1.2	V	
t _{rr}	Reverse	e Recovery Time			0 V, I _{SD} = 8 A,		-	365	-	ns	
Q _{rr}	Reverse	Recovery Charge	(dI _F /dt = 100 A/µs		-	5.9	-	μC		
2. $I_{AS} = 1.6 \text{ A}, \text{ R}_{G} = 3. I_{SD} \le 10 \text{ A}, \text{ di/dt}$	= 25 Ω, Starti ≤ 200 A/μs, \	limited by maximum junction ten ng T _J = 25°C $/_{DD} \le BV_{DSS}$, Starting T _J = 25°C verating temperature typical chara									

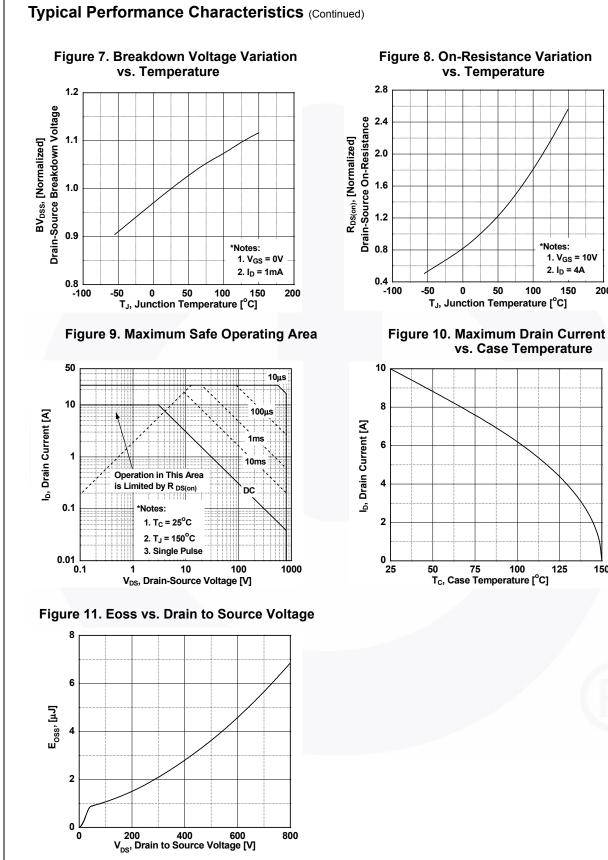


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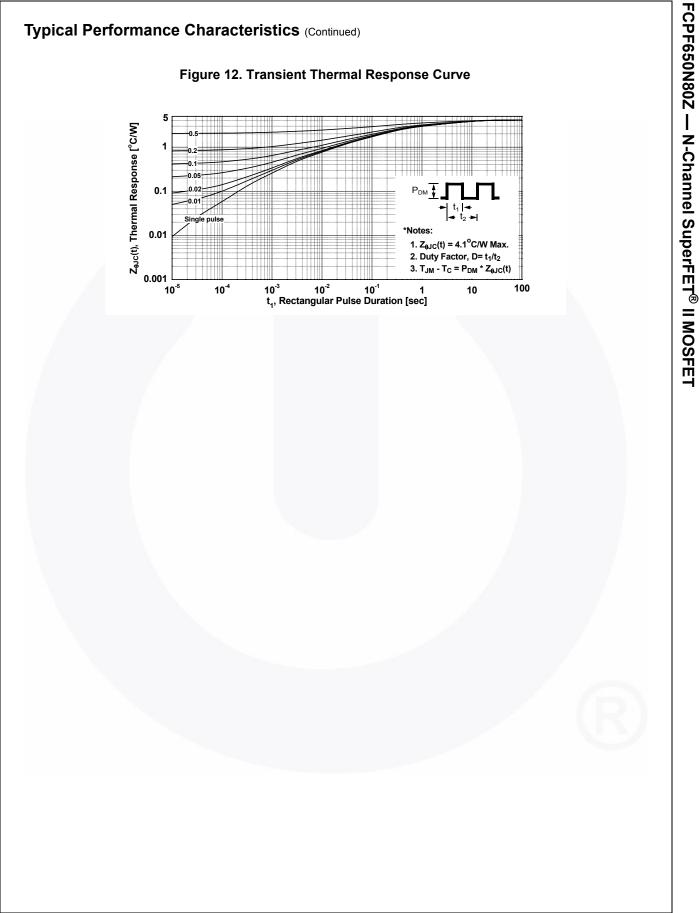
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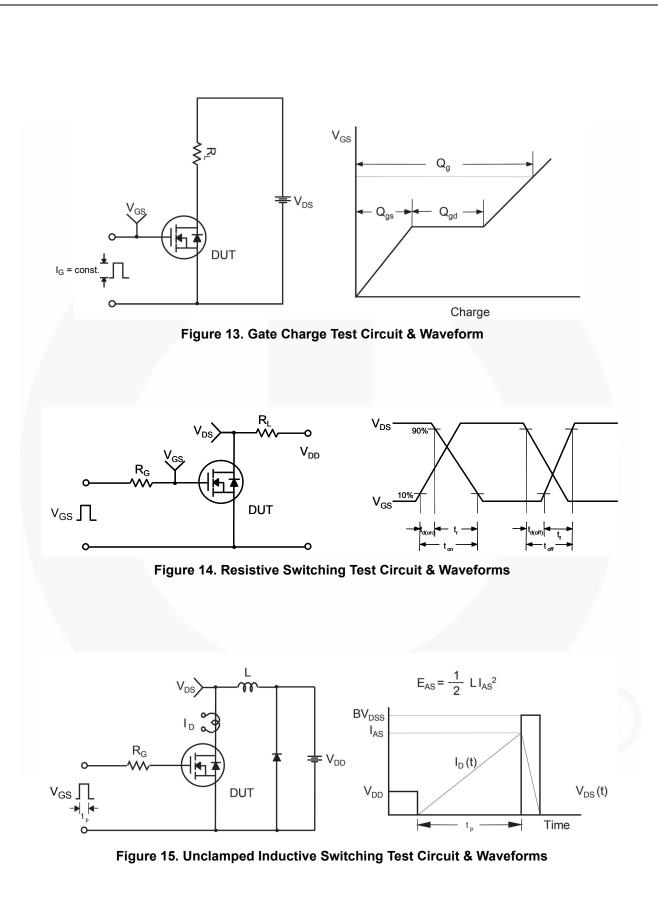
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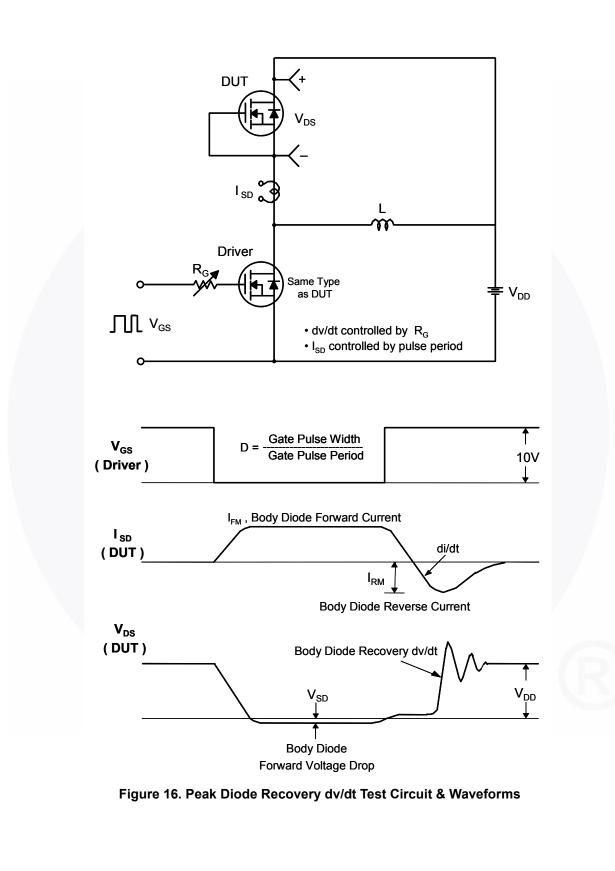
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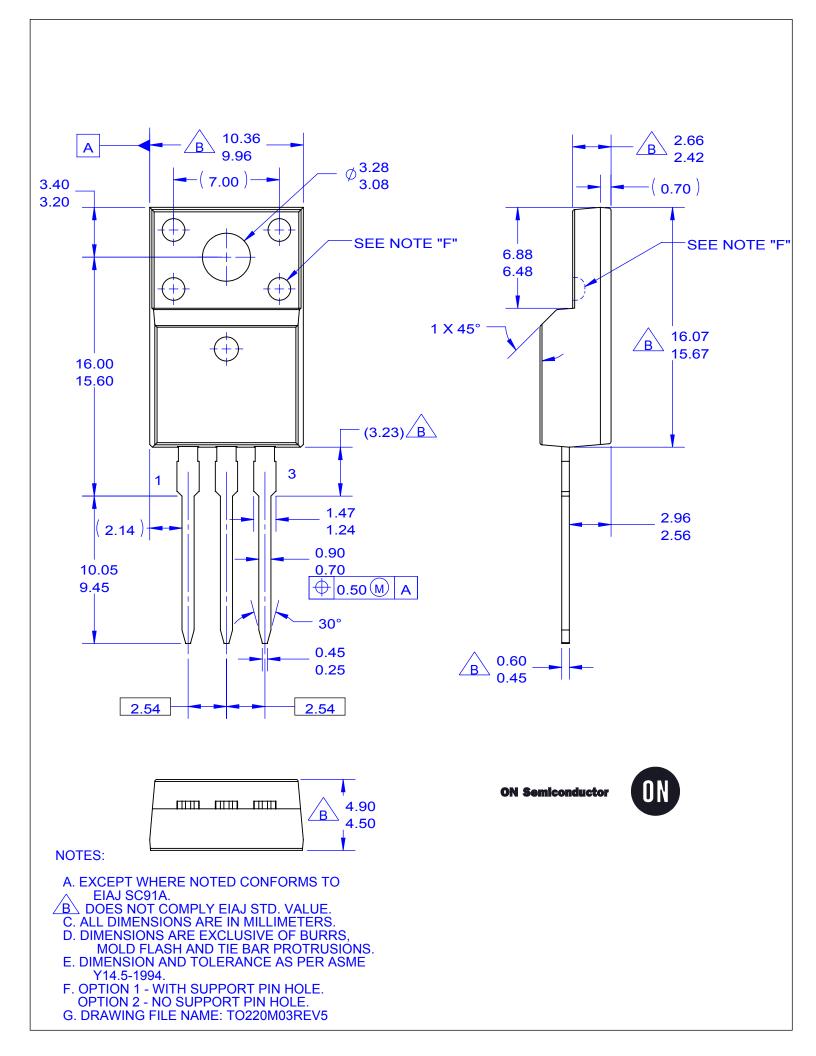




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